## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## FLIP-CHIP SUBSTRATE AND FLIP-CHIP BONDING PROCESS THEREOF

the	specification of whic	ch				
_X	is attached hereto					
	_ was filed on as Application Ser		and was amended on			
apple for on	ecification, including to a cknowledge the plication in accordance I hereby claim fore plication(s) for patentication(s)	the claims, as amended to duty to disclose information with Title 37, Code of the priority benefits under the inventor's certification at or inventor's certification.	nd understand the content of by any amendment referred mation which is material to of Federal Regulations, § 1. der Title 35, United States Co ate listed below and have ficate having a filing date be	ed to above. the patent 56(a). Code, § 119 also identif	ability of this of any foreign ied below any	
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No	
	91136481	Taiwan, R.O.C.	2002/12/18	X		
tra	• • •		) )			
	SEND CORRESPOR	NDENCE TO:		DIRECT TELEPHONE CALLS TO: (Name and telephone number)		
		2800		la Lee		

## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature:	Yor - Wen	Chen	Date:	1/01 03
Sole or First .	Joint Inventor: Yu-V	Ven Chen		
Citizenship: T	Гаiwan, R.O.C.			
Residence ar	nd Post Office Add	ress: 9Fl., No. 582-1, 807, R.O.C.	Heti Rd., S	Sanmin Chiu, Kaohsiung, Taiwan
	Inventor (it any): M	ing-Lun Ho	Date:	Y8 63
	faiwan, R.O.C.			
Residence ar	nd Post Office Addre	ess: No. 67-26, Bauan R.O.C.	Rd., Yungan	Shiang, Kaohsiung, Taiwan 828,
Signature:	clun yeng	Lee	Date:	1/8 03'
	ventor (if any): Chu			
Citizenship: T	āiwan, R.O.C.			
Residence ar	nd Post Office Addr	ess: 6Fl., No. 280, K	aishiuan 4th	Rd., Chianjen Chiu, Kaohsiung,

Taiwan 806, R.O.C.